imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

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Very Low Forward Voltage Trench-based Schottky Rectifier

Exceptionally Low $V_F = 0.53$ V at $I_F = 5$ A

Features

- Fine Lithography Trench–based Schottky Technology for Very Low Forward Voltage and Low Leakage
- Fast Switching with Exceptional Temperature Stability
- Low Power Loss and Lower Operating Temperature
- Higher Efficiency for Achieving Regulatory Compliance
- Low Thermal Resistance
- High Surge Capability
- These Devices are Pb-Free and Halogen Free/BFR Free

Typical Applications

- Switching Power Supplies including Telecom AC to DC Power Stages, LED Lighting and ATX
- High Voltage DC–DC Converters
- Freewheeling and OR-ing Diodes
- Output Rectifier in Welding Power Supplies
- Industrial Automation

Mechanical Characteristics

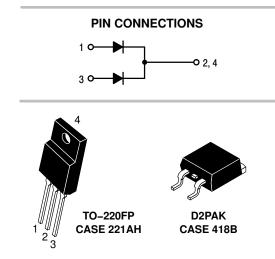
- Case: Epoxy, Molded
- Epoxy Meets Flammability Rating UL 94–0 @ 0.125 in
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Maximum for 10 sec



ON Semiconductor®

http://onsemi.com

VERY LOW FORWARD VOLTAGE, LOW LEAKAGE SCHOTTKY BARRIER RECTIFIERS 40 AMPERES, 200 VOLTS



ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

This document contains information on some products that are still under development. ON Semiconductor reserves the right to change or discontinue these products without notice.

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Forward Current (Rated V _R , T _C = 125°C) NTSB40200CTG Per device (Rated V _R , T _C = 130°C) NTSB40200CTG Per diode (Rated V _R , T _C = 65°C) NTSJ40200CTG Per device (Rated V _R , T _C = 42°C) NTSJ40200CTG Per diode	I _{F(AV)}	40 20 20 20	A
Peak Repetitive Forward Current (Rated V _R , Square Wave, 20 kHz, T _C = 115°C) NTSB40200CTG Per device (Rated V _R , Square Wave, 20 kHz, T _C = 125°C) NTSB40200CTG Per diode (Rated V _R , Square Wave, 20 kHz, T _C = 40°C) NTSJ40200CTG Per device (Rated V _R , Square Wave, 20 kHz, T _C = 25°C) NTSJ40200CTG Per diode	I _{FRM}	80 40 40 40	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I _{FSM}	250	A
Operating Junction Temperature	TJ	-55 to +150	°C
Storage Temperature	T _{stg}	-55 to +150	°C
ESD Rating (Human Body Model)		ЗA	
ESD Rating (Machine Model)		M4	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

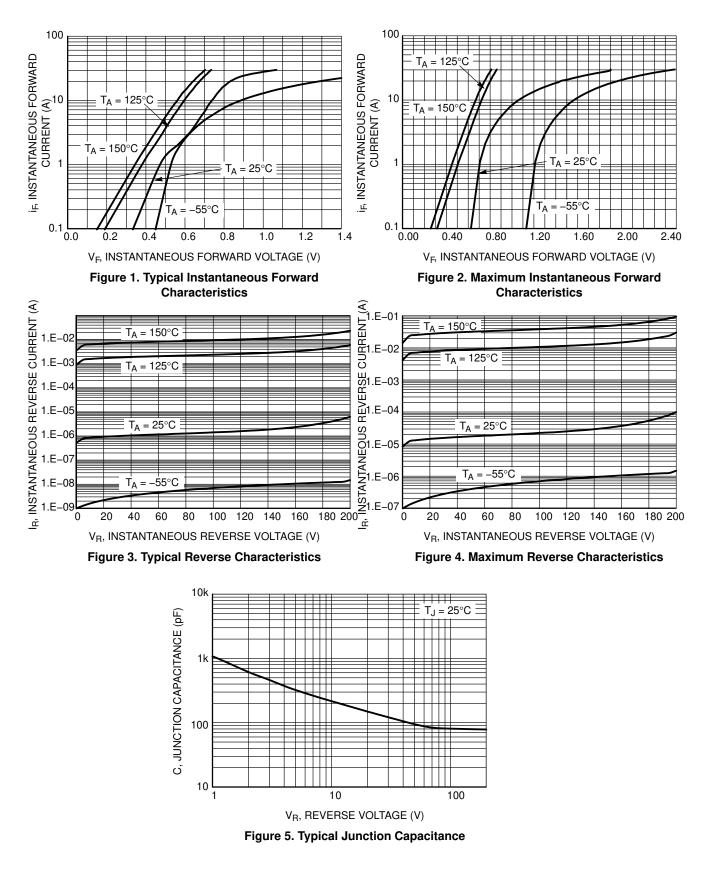
Rating		NTSB40200CTG	NTSJ40200CTG	Unit
Typical Thermal Resistance Junction-to-Case Per Diode Junction-to-Case Per Device	$R_{ ext{ heta}JC}$	1.29 0.79	6.94 6.05	°C/W
Junction-to-Ambient Per Device	$R_{\theta JA}$	40	105	

ELECTRICAL CHARACTERISTICS

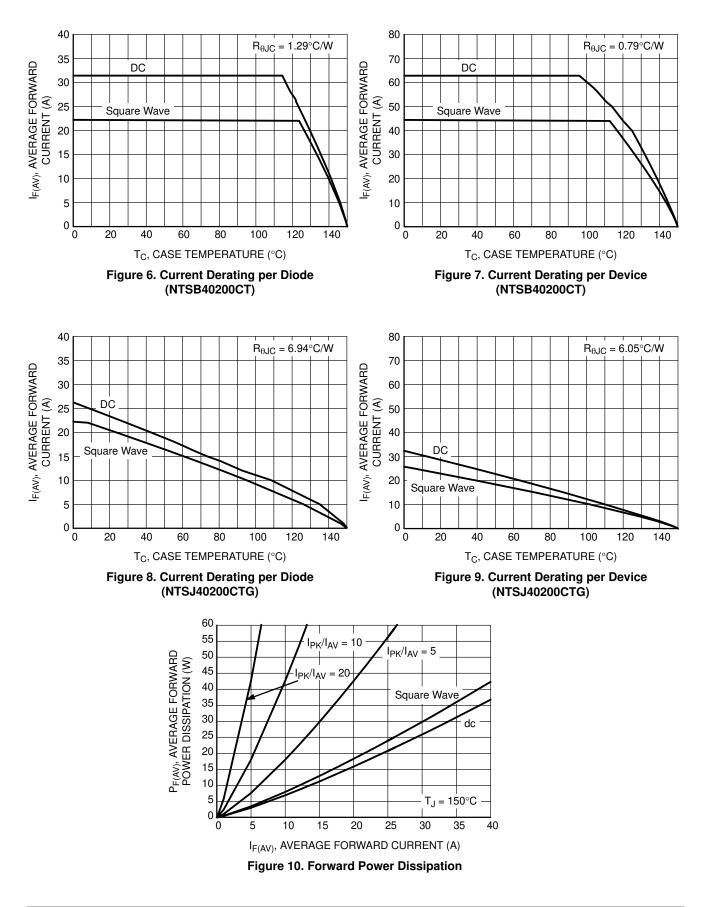
Rating	Symbol	Тур	Max	Unit
Instantaneous Forward Voltage (Note 1)	V _F			V
$(I_{F} = 5 \text{ A}, T_{J} = 25^{\circ}\text{C})$		0.68	-	
(I _F = 10 A, T _J = 25°C)		0.74	-	
(I _F = 15 A, T _J = 25°C)		0.79	_	
$(I_F = 20 \text{ A}, T_J = 25^{\circ}\text{C})$		0.84	1.45	
		0.53 0.60 0.64 0.68	- - 0.80	
Instantaneous Reverse Current (Note 1) $(V_R = 180 V, T_J = 25^{\circ}C)$ (Rated dc Voltage, $T_J = 25^{\circ}C$)	I _R	3 5	100	μA μA
$(V_R = 180 \text{ V}, \text{T}_J = 125^{\circ}\text{C})$ (Rated dc Voltage, T _J = 125^{\circ}\text{C})		5.3 7	_ 30	mA mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. Pulse Test: Pulse Width = $300 \ \mu$ s, Duty Cycle $\leq 2.0\%$

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

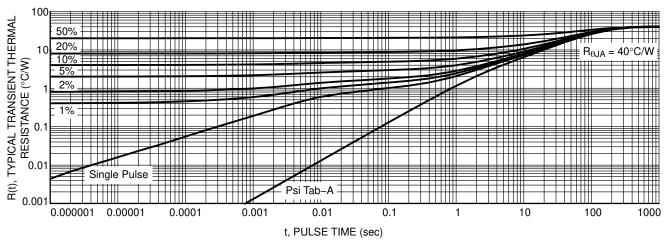


Figure 11. Typical Transient Thermal Response per Device (NTSB40200CTG)

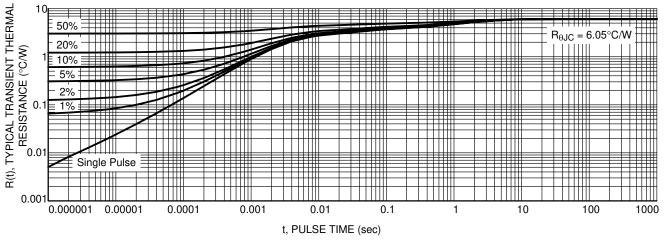
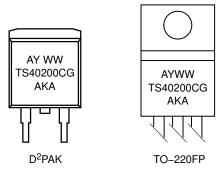


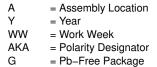
Figure 12. Typical Transient Thermal Response per Device (NTSJ40200CTG)

ORDERING INFORMATION

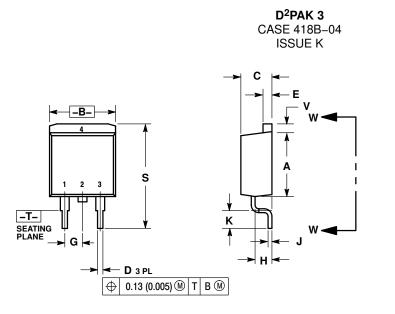
Device	Package	Shipping
NTSB40200CTG	D ² PAK (Pb–Free)	50 Units / Rail
NTSB40200CTT4G	D ² PAK (Pb–Free)	800 / Tape & Reel
NTSJ40200CTG (In Development)	TO-220FP (Halide-Free)	50 Units / Rail

MARKING DIAGRAMS



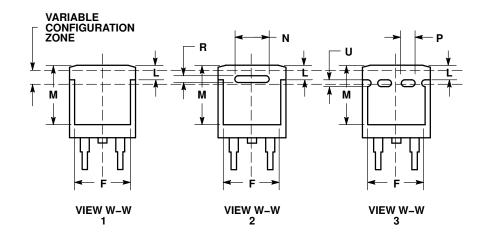


PACKAGE DIMENSIONS



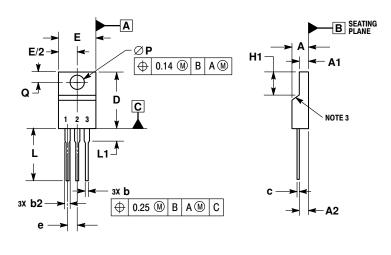
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 418B-01 THRU 418B-03 OBSOLETE, NEW STANDARD 418B-04.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.340	0.380	8.64	9.65
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.83
D	0.020	0.035	0.51	0.89
E	0.045	0.055	1.14	1.40
F	0.310	0.350	7.87	8.89
G	0.100 BSC		2.54 BSC	
н	0.080	0.110	2.03	2.79
J	0.018	0.025	0.46	0.64
Κ	0.090	0.110	2.29	2.79
L	0.052	0.072	1.32	1.83
М	0.280	0.320	7.11	8.13
Ν	0.197	' REF	5.00	REF
Ρ	0.079	REF	2.00	REF
R	0.039	REF	0.99	REF
S	0.575	0.625	14.60	15.88
v	0.045	0.055	1.14	1.40



PACKAGE DIMENSIONS

TO-220 FULLPACK, 3-LEAD CASE 221AH ISSUE D



NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14 5M 1994

2.

3.

Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. CONTOUR UNCONTROLLED IN THIS AREA. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE TO BE MEASURED AT OUTERMOST EXTREME OF THE PLASTIC BODY.

5. DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2 00

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.30	4.70	
A1	2.50	2.90	
A2	2.50	2.70	
b	0.54	0.84	
b2	1.10	1.40	
C	0.49	0.79	
D	14.70	15.30	
Е	9.70	10.30	
е	2.54 BSC		
H1	6.70	7.10	
L	12.70	14.73	
L1		2.10	
Р	3.00	3.40	
Q	2.80	3.20	

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